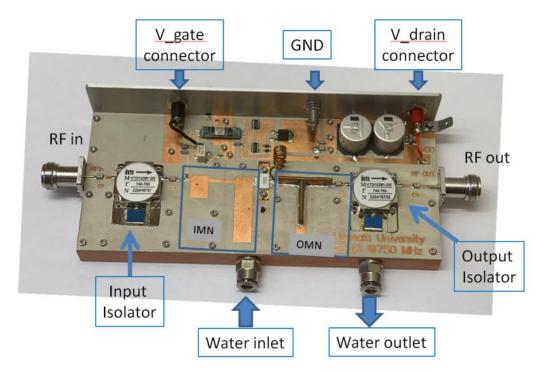


Outline

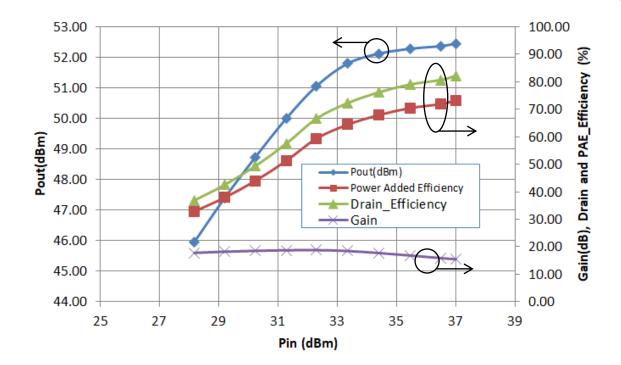
- This presentation outlines the design and implementation of a 1 kW Gallium Nitride (GaN) RF solid-state power amplifier operating at 750 MHz. It builds upon the 200 W solid-state amplifier. Six 200 W amplifiers are combined to achieve a 1 kW output, requiring a low loss combiner.
- The designs of a binary 6:1 power combiner and a 1:6 power splitter are also presented in this presentation today.
- A comprehensive testing show 82.45% drain Efficiency at 1148 W output power.
- This amplifier will be used as a driver amplifier for the CFA amplifier. The whole chain could serve as an RF power generator for the RFQ at 750 MHz that was developed at CERN.



D13.3: GaN RF Amplifier Module at kW level



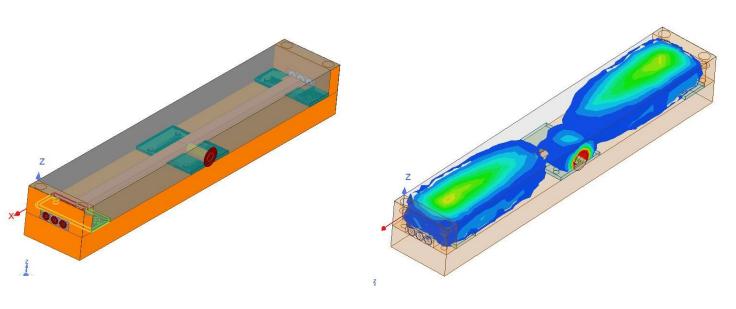
Fabricated 200W solid-state RF power amplifier at 750-MHz



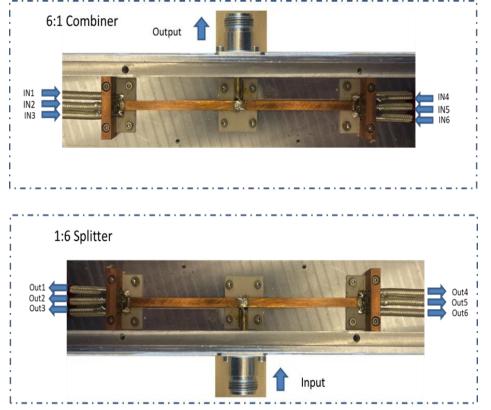
Measurement results of 200W solid-state RF power amplifier at 750 MHz



D13.3: GaN RF Amplifier Module at kW level



Simulated high power 1:6:1 splitter/combiner at 750 MHz.

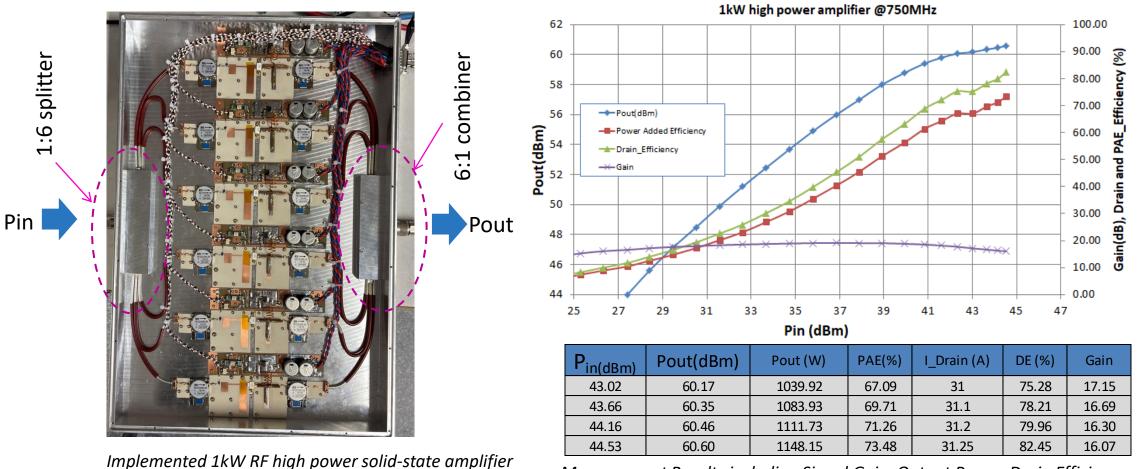


Implemented high power 1:6:1 splitter/combiner at 750 MHz with 0.15 dB insertion loss.



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D13.3: GaN RF Amplifier Module at kW level



including DC bias circuits, 6 200-w RF power amplifiers,

and the RF splitter and combiner.

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Measurement Results including Signal Gain, Output Power, Drain Efficiency, and Power Added Efficiency at 750MHz.

Comparison and conclusion

Reference	Operating class	Enin. (MHz)	Emax (MHz)	P _{out} (dBm)	Gain (dB)	PAE _{nin}	Package/Die	Technology	Institution
2023 [This work]	Class B	750	-	60.60	16.07	73.48	packaged	GaN	FREIA – Uppsala U.
2020[1]	Push pull	24.5	27	59.8	25	83	packaged	LDMOS	FREIA – Uppsala U.
2019[2]	Class AB	400	450	60	15	-	Packaged	GaN	SSPL - Delhi
2018[3]	Class AB	UHF	-	67.2	-	55	Packaged	GaN	CETC - Nanjing
2017[4]	Class AB	1200	1400	64	16.7	55	packaged	LDMOS	USTB - Beijing
2016[5]	Class AB	352	-	60.9	20.5	71	Packaged	LDMOS	FREIA – Uppsala U.
2016[6]	Class AB	200	500	40	18	71	packaged	GaN	CESAT - Islamabad
2016[7]	Class B	420	450	60	25	73	3 chip Packaged	GaN	Integra Tech CA
2020[8]	Class E	400.8	-	63.6	22	70	Die	GaN	Integra Tech CA
2018[9]	Class E	680	750	47	-	80	packaged	GaN	U. of Cantabria
2018[10]	Class E	100	-	60.8	-	82	packaged	LDMOS	FREIA – Uppsala U.
2017[11]	Harmonic tuned	420	450	60	40 (two stages)	75	Packaged	GaN	Integra Tech CA
2017[12]	Class E	670	900	44.7	-	70	packaged	GaN	U. of Cantabria
2016[13]	Class F	704	-	58	-	79	packaged	GaN	Green Mountain Radio Research
2016[14]	Class F	550	950	40	15	75	packaged	GaN	U. of Calgary
	Class F	550	1100	40	10	74	packaged	GaN	Cardiff U.

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However, achieving high power efficiency is often a trade-off with other parameters such as bandwidth, linearity, gain, and cost. Nonetheless, the design with an 82.45% power efficiency and 1-kW output power at 750 MHz frequency is a commendable and demonstrates a well-designed and efficient amplifier based on GaN technology. It also shows the feasibility of implementing a high efficiency, high-power solid–state amplifier with high reliability and high MTBF features.

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Thank you for your attention!



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